

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE0130GA uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED! 100% ΔVds TESTED!

General Features

• $V_{DS} = 100V, I_{D} = 30A$

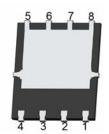
 $R_{DS(ON)} < 32m\Omega$ @ $V_{GS}=10V$ (Typ:25m Ω)

 $R_{DS(ON)} < 35m\Omega$ @ V_{GS} =4.5V (Typ:28m Ω)

- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
 Excellent package for good heat dissipation

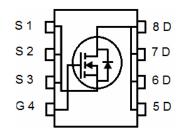
DFN 5X6





Top View

Bottom View



Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0130GA	NCE0130GA	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage	100	V
V _G s	Gate-Source Voltage	±20	V
I _D	Drain Current-Continuous	30	Α
I _D (100℃)	Drain Current-Continuous(TC=100℃)	21	Α
I _{DM}	Pulsed Drain Current	120	Α
P_{D}	Maximum Power Dissipation	85	W
	Derating factor	0.68	W/°C
E _{AS}	Single pulse avalanche energy (Note 5)	200	mJ
T_{J}, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	°C

Thermal Characteristic

R _{BJC} Thermal Resistance, Junction-to-Case (Note 2) 1.5 °C/
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Sym	nbol F	Parameter	Condition	Min	Тур	Max	Unit
Off Characteristics				•			
BV _{DSS}	Drain-Source Breakdo	wn Voltage	V _{GS} =0V I _D =250μA	100	-	-	V
I _{DSS}	Zero Gate Voltage Dra	ain Current	V _{DS} =100V,V _{GS} =0V	-	-	1	μΑ
I _{GSS}	Gate-Body Leakage Current		V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (N	lote 3)						
V _{GS(th)}	Gate Threshold V	'oltage	$V_{DS}=V_{GS},I_{D}=250\mu A$	1.3	1.9	2.5	V
	Drain-Source On-State Resistance		V _{GS} =10V, I _D =15A	-	25	32	m0
R _{DS(ON)}			V _{GS} =4.5V, I _D =15A		28	35	mΩ
g _{FS}	Forward Transcond	luctance	V _{DS} =5V,I _D =15A	-	15	-	S
Dynamic Characteris	itics (Note4)						
C _{lss}	Input Capacita	nce	\/ F0\/\/ 0\/	-	2479	-	PF
C _{oss}	Output Capacita	ance	V_{DS} =50V, V_{GS} =0V, F=1.0MHz	-	96	-	PF
C _{rss}	Reverse Transfer Ca	pacitance	F=1.UIVID2	-	79	-	PF
Switching Characteri	istics (Note 4)						
t _{d(on)}	Turn-on Delay 1	Гime		-	9	-	nS
t _r	Turn-on Rise T	ïme	V_{DD} =50V, R_L =3.3 Ω	-	9	-	nS
t _{d(off)}	Turn-Off Delay	Time	V_{GS} =10 V , R_{GEN} =3 Ω	-	32	-	nS
t _f	Turn-Off Fall T	ime		-	8	-	nS
Qg	Total Gate Cha	arge	\/ -50\/ -454	-	67.2	-	nC
Q _{gs}	Gate-Source Ch	arge	V _{DS} =50V,I _D =15A,	-	9.4	-	nC
Q_{gd}	Gate-Drain Cha	arge	V _{GS} =10V	-	15.5	-	nC
Drain-Source Diode	Characteristics						
V _{SD}	Diode Forward Volta	age (Note 3)	V _{GS} =0V,I _S =15A	-	-	1.2	V
Is	Diode Forward Curre	ent (Note 2)	-	-	-	30	Α
t _{rr}	Reverse Recovery	Time	TJ = 25°C, IF = 15A	-	32	-	nS
Qrr	Reverse Recovery	Charge	di/dt = 100A/µs ^(Note3)	-	53	-	nC
t _{on}	Forward Turn-On	Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				y LS+LD)

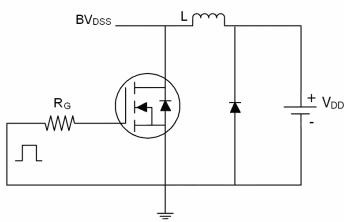
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t \leq 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS Condition : Tj=25 $^{\circ}\text{C}$,VDD=50V,VG=10V,L=0.5mH,Rg=25 Ω ,

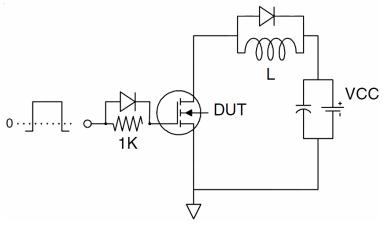


Test Circuit

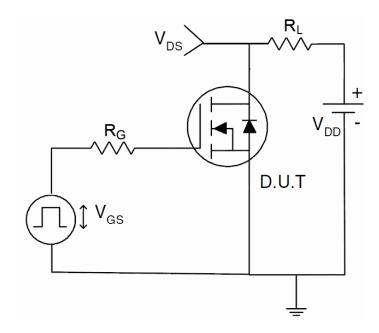
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

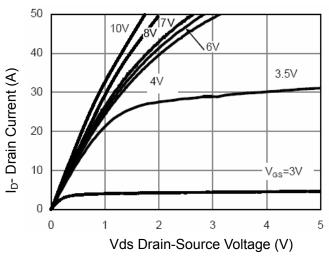


Figure 1 Output Characteristics

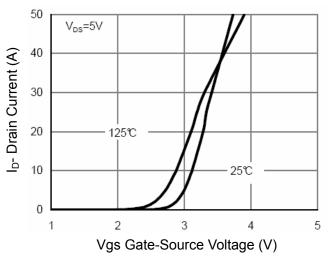


Figure 2 Transfer Characteristics

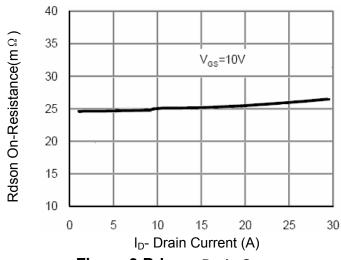


Figure 3 Rdson- Drain Current

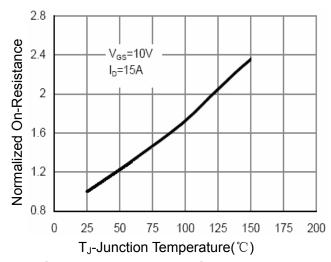


Figure 4 Rdson-JunctionTemperature

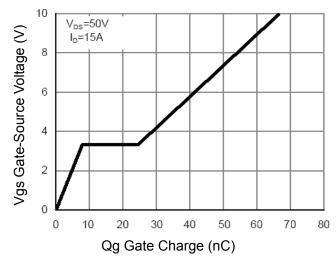


Figure 5 Gate Charge

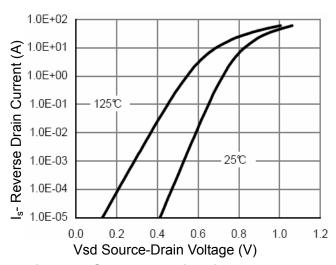
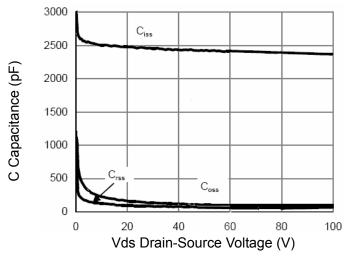


Figure 6 Source- Drain Diode Forward





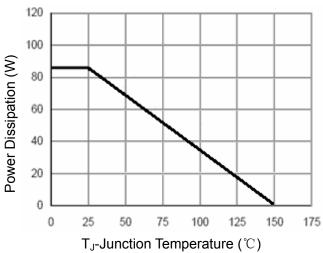
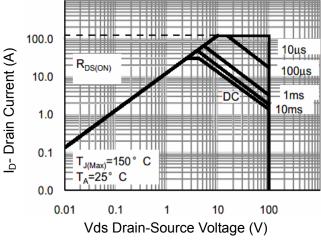


Figure 7 Capacitance vs Vds





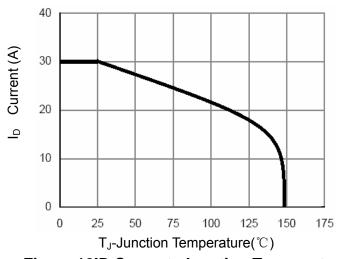
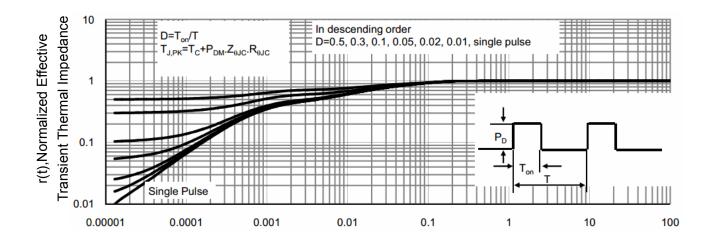


Figure 8 Safe Operation Area

Figure 10ID Current- Junction Temperature

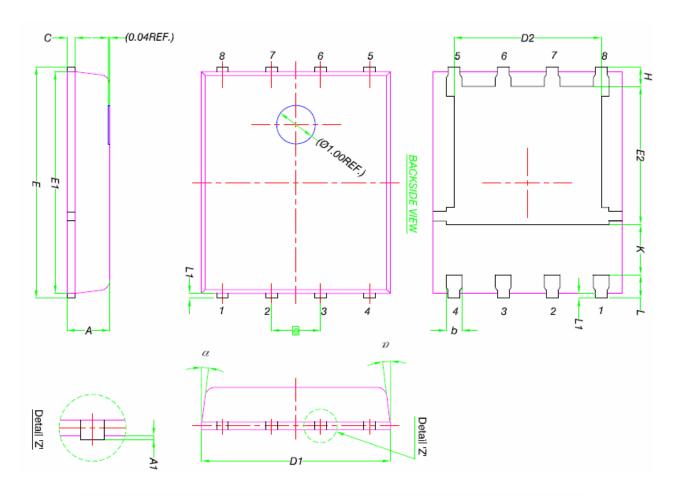


Square Wave Pluse Duration(sec)

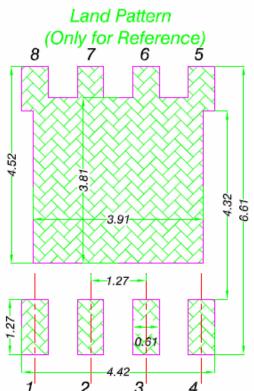
Figure 11 Normalized Maximum Transient Thermal Impedance



DFN5X6-8L Package Information



544	MILLIMETERS				
DIM.	MIN.	NOM.	MAX.		
Α	0.90	1.00	1.10		
A1	0	-	0.05		
b	0.33	0.41	0.51		
С	0.20	0.25	0.30		
D1	4.80	4.90	5.00		
D2	3.61	3.81	3.96		
Ε	5.90	6.00	6.10		
E1	5.70	5.75	5.80		
E2	3.38	3.58	3.78		
е	1.27 BSC				
Н	0.41	0.51	0.61		
K	1.10	-	-		
L	0.51	0.61	0.71		
L1	0.06	0.13	0.20		
α	<i>0</i> °	-	12°		



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